

MAR 15 2005

Application No.: 10/055,499

Docket No.: JCLA8534-R

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of :)	
)	
LEE et al.)	Examiner : THAI, LUAN C
)	
Serial No. : 10/055,499)	Art Unit : 2829
)	
Filed : January 22, 2002)	Docket No. : JCLA8534-R
)	
For : INTEGRATED CHIP PACKAGE)	
STRUCTURE USING ORGANIC)	
SUBSTRATE AND METHOD OF)	
MANUFACTURING THE SAME)	

PRELIMINARY AMENDMENT

MAIL STOP AF
COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450

Dear Sir:

Prior to the examination on merits, please amend the above-identified application as shown in the attached sheets. No new matter has added through the amendment. Entry of the amendment and consideration of the following remarks are requested.